



06-26-2006

Attorney Docket No. SUN05-0862



FORM PTO-1595

R 103263846 COVER SHEET  
PATENTS ONLY

U.S. DEPARTMENT OF COMMERCE

1-31-92

Patent and Trademark Office

To the Assistant Commissioner for Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Arthur R. Zingher, Bruce M. Guenin, Ronald Ho, Robert J. Drost

2. Name and address of receiving party(ies):

Name: Sun Microsystems, Inc.

Street Address: 4150 Network Circle

City: State: Zip: Santa Clara, CA 95054

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Additional name(s) &amp; address(es) attached?

☐ Yes ☒ NoExecution Date: 28 May 2006, 09 May 2006, 03 May 2006,  
20 May 2006

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 28 May 2006

A. Patent Application No.(s): 11/418,986

B. Patent No.(s):

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: A. Richard Park  
Park, Vaughan & Fleming LLP  
2820 Fifth Street  
Davis, CA 95618-7759

Attorney Docket No.: SUN05-0862

6. Total number of applications and patents involved: [1]

7. Total fee (37 CFR 3.41) ..... \$40.00

☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

## DO NOT USE THIS SPACE

9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Edward J. Grundler

Name of Person Signing

  
Signature

19 June 2006

Date

Total number of pages including cover sheet, attachments and document: [9]

#corporate power of attorney

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02 FC:0021

40.00 DP

PATENT  
REEL: 018012 FRAME: 0307

**CORPORATE ASSIGNMENT**

WHEREAS, the undersigned,

Arthur R. Zingher  
 Bruce M. Guenin  
 Ronald Ho  
 Robert J. Drost

1941 California Street, Apt. 2, Mountain View, CA 94040  
 5013 San Joaquin Drive, San Diego, CA 92109  
 2761 Doverton Square, Mountain View, CA 94040  
 2211 Via Maderos, Los Altos, CA 94024

hereinafter termed "Inventor(s)", have invented certain new and useful improvements in

*STRUCTURES AND METHODS FOR A FLEXIBLE BRIDGE THAT SIMPLIFIES CHIP ALIGNMENT*

and have executed a declaration or oath for an application for a United States patent disclosing and identifying the invention:

\_\_\_ On the \_\_\_ day of \_\_\_, 20\_\_\_;

Or

X  Said application having Application Number  11/418,986  and filed on  04 May 2006 ; and

WHEREAS,  Sun Microsystems, Inc.  a corporation of the State of  Delaware , having a place of business at  4150 Network Circle, Santa Clara, CA 95054 , (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventor(s) (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor(s) to have been received in full from said Assignee:

1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation

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3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.

4. Said Inventor(s) hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below.

Arthur R Zingher

Arthur R. Zingher

2006 May 28

Date

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Bruce M. Guenin

Date

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Ronald Ho

Date

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Robert J. Drost

Date

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Date

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Arthur R. Zingher

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Bruce M. Guenin

Date



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Ronald Ho5/9/06  
Date

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Robert J. Drost

Date

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Ronald Ho

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5/3/06

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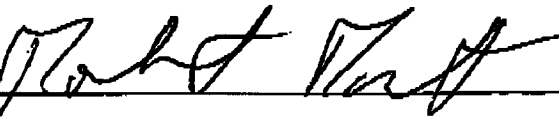
Bruce M. Guenin

Date

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Ronald Ho

Date



5-20-06

Robert J. Drost

Date

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Date